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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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HAT2218R

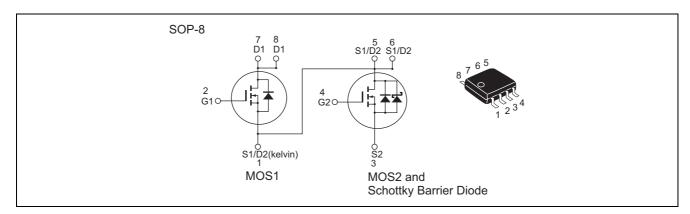
Silicon N Channel Power MOS FET with Schottky Barrier Diode High Speed Power Switching

REJ03G0396-0300 Rev.3.00 Aug.23.2004

Features

- Low on-resistance
- Capable of 4.5 V gate drive
- High density mounting
- Built-in Schottky Barrier Diode

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

		Rat		
Item	Symbol	MOS1	MOS2 & SBD	Unit
Drain to source voltage	V _{DSS}	30	30	V
Gate to source voltage	V _{GSS}	±20	±12	V
Drain current	I _D	7.5	8.0	А
Drain peak current	I _{D(pulse)} Note1	60	64	А
Reverse drain current	I _{DR}	7.5	8.0	Α
Channel dissipation	Pch Note2	1.5	1.5	W
Channel temperature	Tch	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. 1 Drive operation; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10 s

Electrical Characteristics

• MOS1

 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}		_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}		_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.5	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	19	24	mΩ	$I_D = 3.75 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note3}}$
resistance	R _{DS(on)}	_	27	40	mΩ	$I_D = 3.75 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note3}}$
Forward transfer admittance	y _{fs}	9	15	_	S	$I_D = 3.75 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note3}}$
Input capacitance	Ciss	_	630	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	155	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	57	_	pF	f = 1MHz
Total gate charge	Qg	_	4.6	_	nC	V _{DD} = 10 V
Gate to source charge	Qgs	_	2.2	_	nC	V _{GS} = 4.5 V
Gate to drain charge	Qgd	_	1.2	_	nC	I _D = 7.5 A
Turn-on delay time	t _{d(on)}	_	7	_	ns	V _{GS} =10 V, I _D = 3.75 A
Rise time	t _r	_	14	_	ns	V _{DD} ≈ 10 V
Turn-off delay time	t _{d(off)}	_	36	_	ns	$R_L = 2.66 \Omega$
Fall time	t _f	_	3.4	_	ns	$R_g = 4.7 \Omega$
Body-drain diode forward voltage	V_{DF}	_	0.85	1.11	V	$IF = 7.5 A, V_{GS} = 0^{Note3}$
Body-drain diode reverse	t _{rr}	_	17	_	ns	IF =7.5 A, V _{GS} = 0
recovery time						diF/ dt = 100 A/μs

Notes: 3. Pulse test

• MOS2 & Schottky Barrier Diode

 $(Ta = 25^{\circ}C)$

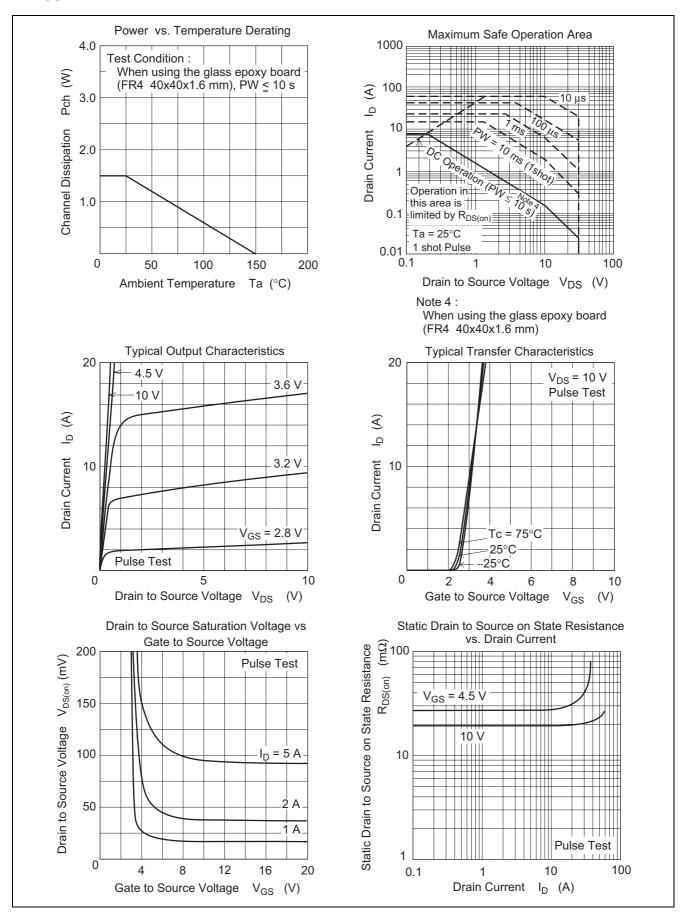
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	m A	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.4	_	2.5	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	17	22	mΩ	$I_D = 4 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note3}}$
resistance	R _{DS(on)}	_	21	29	mΩ	$I_D = 4 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note3}}$
Forward transfer admittance	y _{fs}	15	25	_	S	$I_D = 4 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note3}}$
Input capacitance	Ciss	_	1330	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	230	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	92	_	pF	f = 1MHz
Total gate charge	Qg	_	11	_	nC	V _{DD} = 10 V
Gate to source charge	Qgs	_	3.8	_	nC	V _{GS} = 4.5 V
Gate to drain charge	Qgd	_	3.2	_	nC	I _D = 8 A
Turn-on delay time	t _{d(on)}	_	10	_	ns	V _{GS} = 10 V, I _D = 4 A
Rise time	t _r	_	16	_	ns	V _{DD} ≈ 10 V
Turn-off delay time	t _{d(off)}	_	43	_	ns	$R_L = 2.5 \Omega$
Fall time	t _f	_	3.9	_	ns	$R_g = 4.7 \Omega$
Schottky Barrier diode forward voltage	V_{F}	_	0.5	_	V	$IF = 3.5 A, V_{GS} = 0^{Note3}$
Body-drain diode reverse	t _{rr}	_	15	_	ns	IF = 8 A, V _{GS} = 0
recovery time						diF/ dt = 100 A/μs

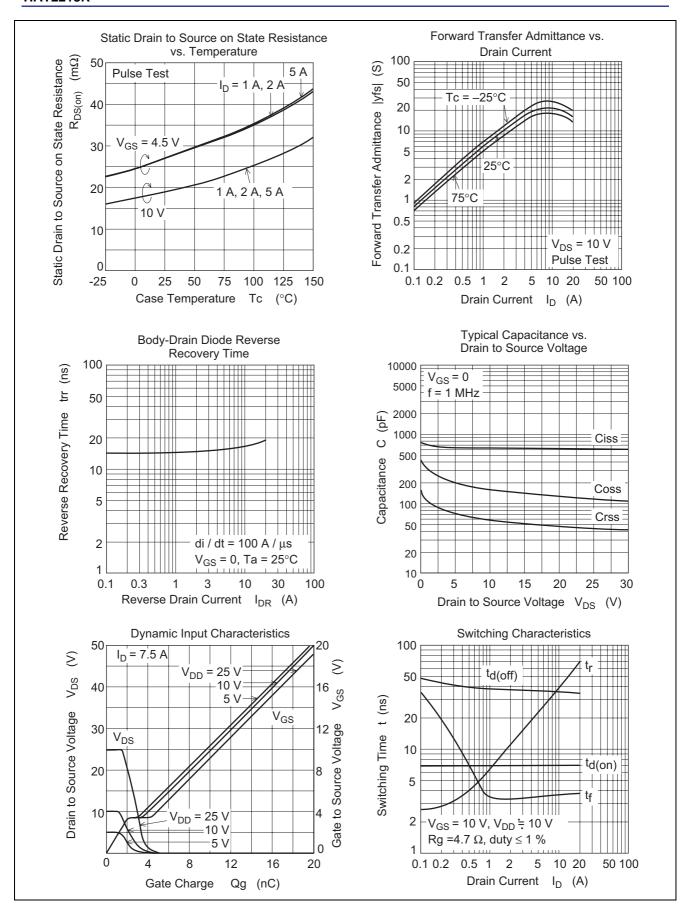
Notes: 3. Pulse test

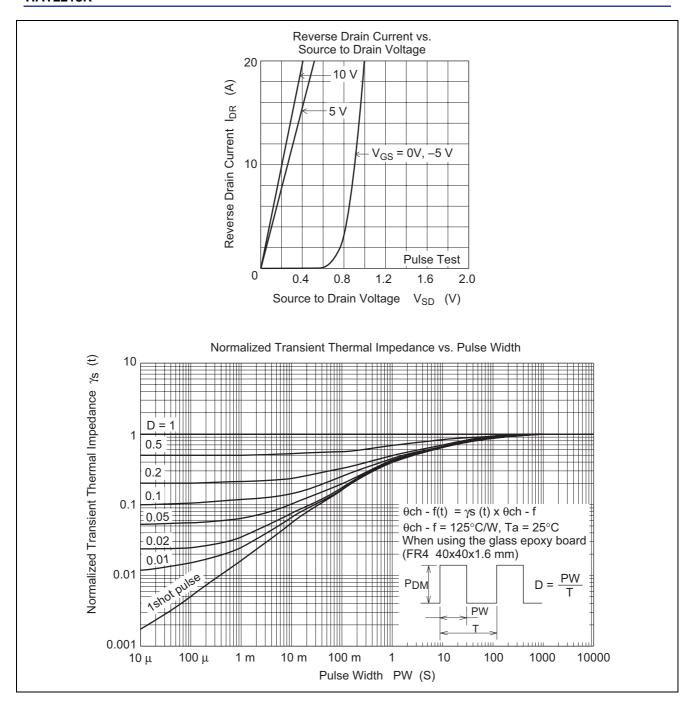


Main Characteristics

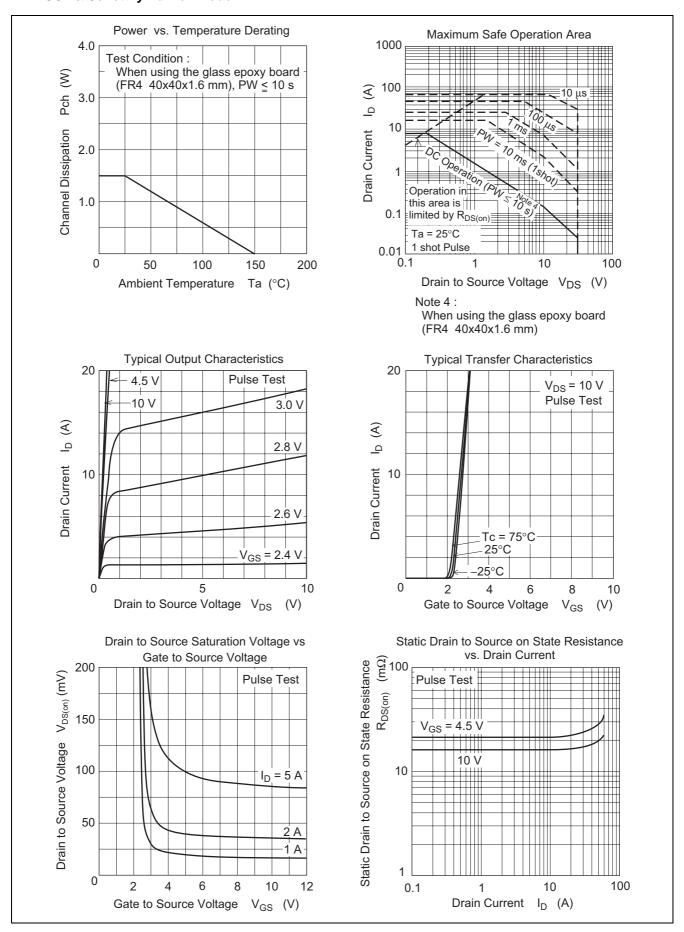
• MOS1

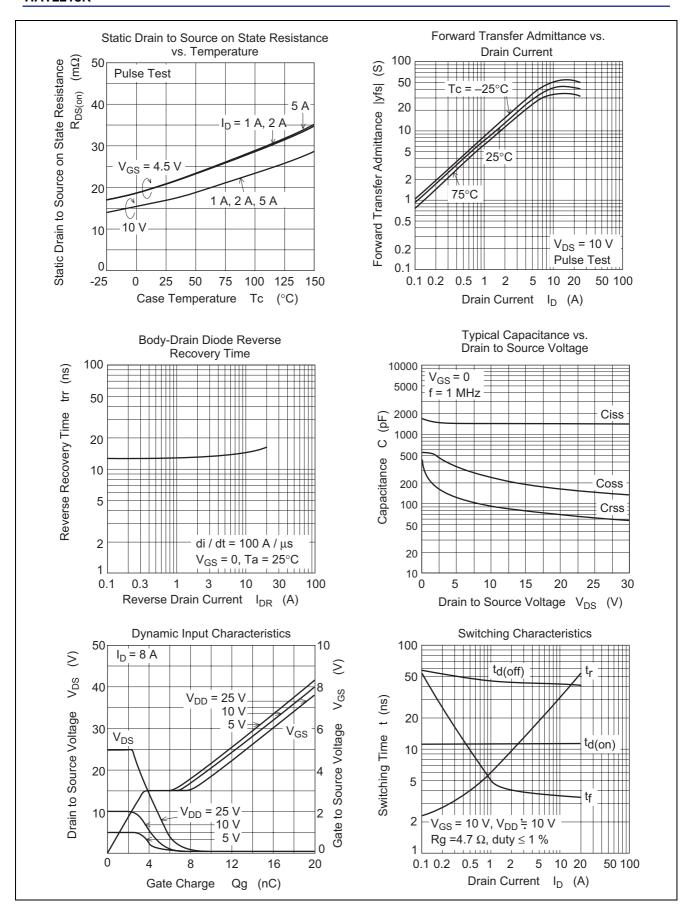


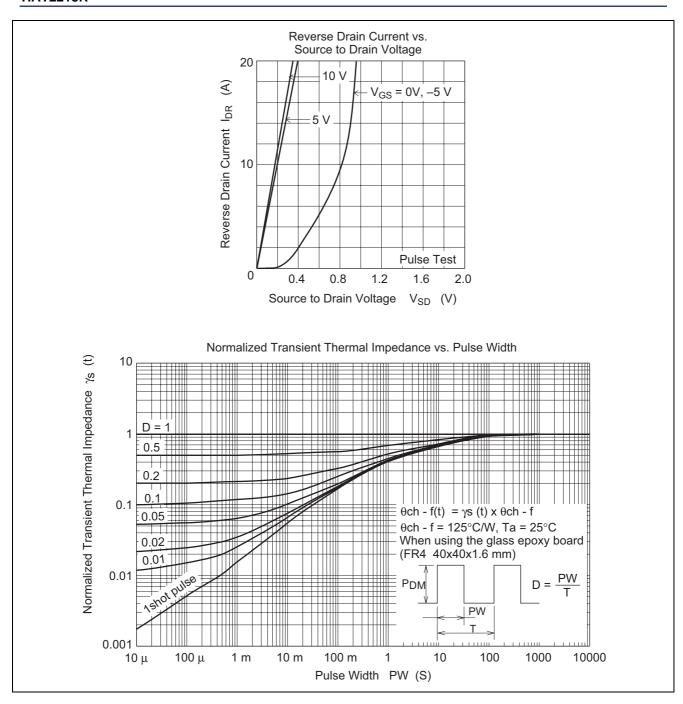




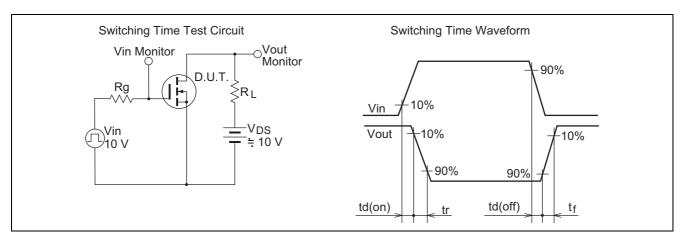
• MOS2 & Schottky Barrier Diode



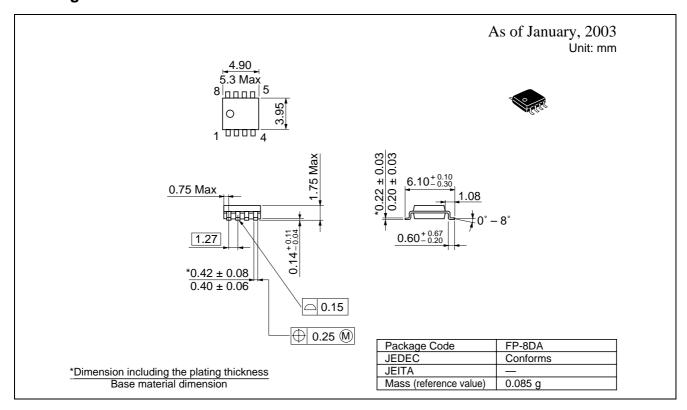




Common



Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2218R-EL-E	2500 pcs	Taping

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